

SMD • Low Power LED 45-21/XK2C- SXXXXXXXXX/2T



Features

- · P-LCC-2 package
- Top view LED
- · Wide viewing angle:120°
- · High Luminous intensity
- High Efficacy
- · Pb-free
- · RoHS-compliant
- · ANSI binning

Description

The Everlight 45-21 package has high efficacy, high CRI, low power consumption, wide viewing angle and a compact form factor. These features make this package an ideal LED for all lighting applications.

Applications

- · General lighting
- · Decorative and Entertainment Lighting
- Indicators
- · Illumination
- · Switch lights

Product Number Explanation

45-21 / X K 2 C - S XX XX XX XX XX / 2T

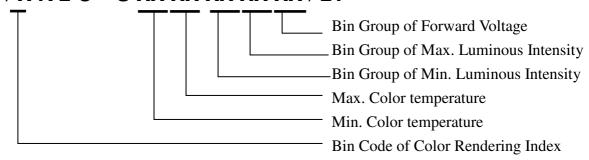


Table of Color Rendering Index

Symbol	Description
M	CRI(min): 60
N	CRI(min): 65
L	CRI(min): 70
Q	CRI(min): 75
K	CRI(min): 80
Н	CRI(min): 90

Note:

1. Tolerance of Color Rendering Index: ±2

Example:

45-21/KK2C-S4040AC4CB41/2T

CRI	Min=80
CCT	3710~4260 K
IV	1800mcd~2400mcd
VF	2.9V~3.4V



Mass Production list

Product	CRI min.	ССТ(К)	lv (mcd) Min.	lv(mcd) Max.	Ф(lm) Тур.
45-21/KK2C-S30308BACB41/2T	80	3000	1600	2000	5.6
45-21/KK2C-S4040AC4CB41/2T	80	4000	1800	2400	6.2



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
InGaN	Neutral White Warm White	Water Clear

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	l _F	30	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA	
Power Dissipation	Pd	110	mW	
Electrostatic Discharge(HBM)	ESD	1000	V	
Thermal Resistance	Rth _{J-L}	200	K/W	
Operating Temperature	T _{opr}	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$	
Soldering Temperature	T_{sol}	Reflow Soldering : 260 $^{\circ}\mathbb{C}$ for 10 sec. Hand Soldering : 350 $^{\circ}\mathbb{C}$ for 3 sec.		

Note:

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Viewing Angle	$2\theta_{1/2}$		120		deg	$I_F=20mA$
Reverse Current	I _R			50	μA	V _R =5V

The products are sensitive to static electricity and must be carefully taken when handling products.



Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition	
4B	1200	1400			
6B	1400	1600		I _F =20mA	
8B	1600	1800	<u> </u>		
AC	1800	2000	– mcd		
2C	2000	2200	IIICu		
4C	2200	2400	<u> </u>		
6C	2400	2600	_		
8C	2600	2800			

Note:

Tolerance of Luminous Intensity: ±11%

Bin Range of Forward Voltage

Group	Bin Code	Min.	Max.	Unit	Condition
	34	2.7	2.8	_	
	35	2.8	2.9		
	36	2.9	3.0	_	
	37	3.0	3.1		
B41	38	3.1	3.2	_ V	I _F =20mA
	39	3.2	3.3		
	40	3.3	3.4	<u></u>	
	41	3.4	3.5		
	42	3.5	3.6	_	

Note:

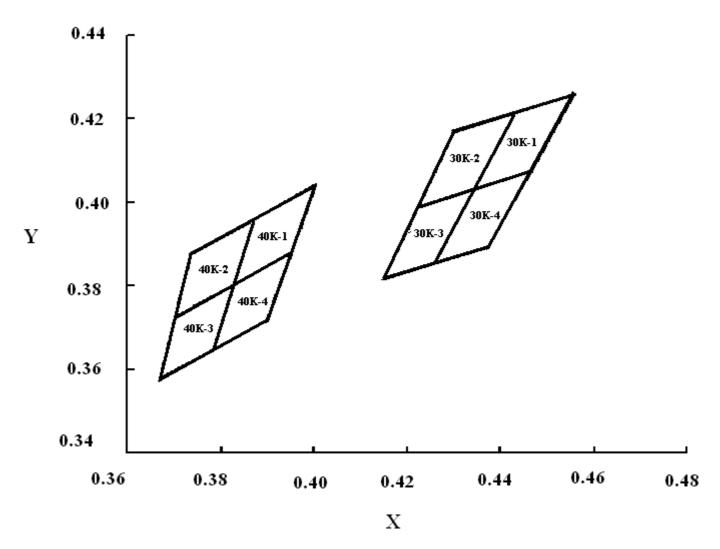
^{1.} Tolerance of Forward Voltage: ±0.05V

Bin Range of Chromaticity Coordinates

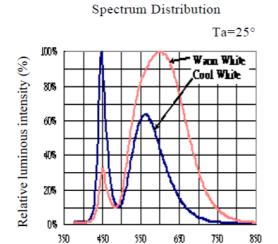
ССТ	Bin Code	CIE_x	CIE_y	ССТ	Bin Code	CIE_x	CIE_y
		0.4562	0.4260			0.4006	0.4004
	30K-1	0.4431	0.4213		40K-1	0.3871	0.3959
	30K-1	0.4345	0.4033			0.3828	0.3803
		0.4468	0.4077			0.3952	0.3880
		0.4431	0.4213			0.3871	0.3959
	30K-2	0.4299	0.4165	4000K	40K-2	0.3736	0.3874
		0.4223	0.3990			0.3703	0.3726
3000K		0.4345	0.4033			0.3828	0.3803
3000K	30K-3	0.4345	0.4033		40K-3	0.3828	0.3803
		0.4223	0.3990			0.3703	0.3726
		0.4147	0.3814			0.3670	0.3578
		0.4260	0.3854			0.3784	0.3647
		0.4468	0.4077		40K-4	0.3952	0.3880
	30K-4	0.4345	0.4033			0.3828	0.3803
	30K-4	0.4260	0.3854			0.3784	0.3647
		0.4373	0.3893			0.3898	0.3716

Note: Tolerance of Chromaticity Coordinates: ±0.01

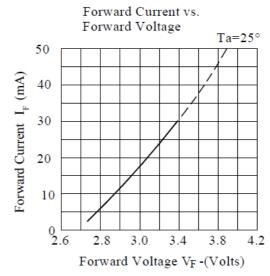
The C.I.E. 1931 Chromaticity Diagram

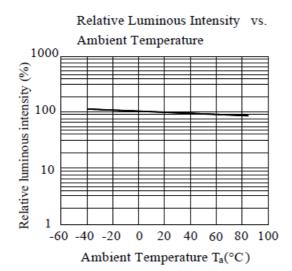


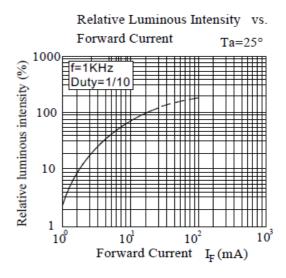
Typical Electro-Optical Characteristics Curves

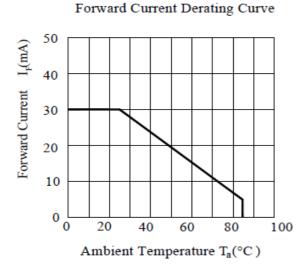


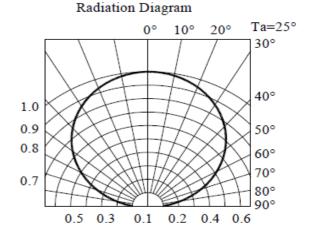
Wavelength λ(nm)



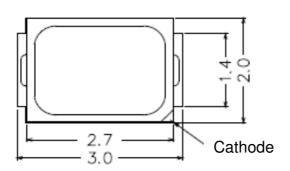


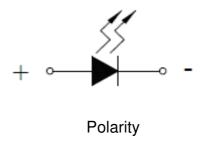


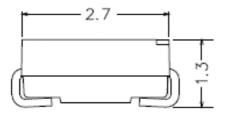


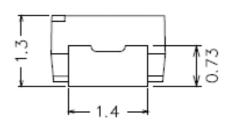


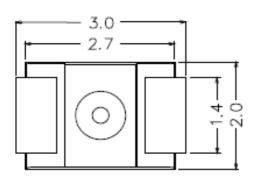
Package Dimension

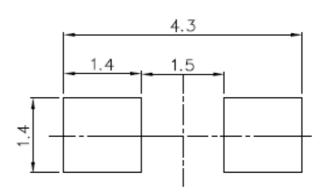












Recommended soldering pad design

Note:

Tolerance unless mentioned is ±0.1mm; Unit = mm



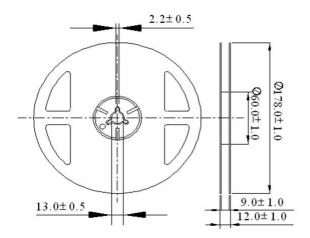
Moisture Resistant Packing Materials

Label Explanation

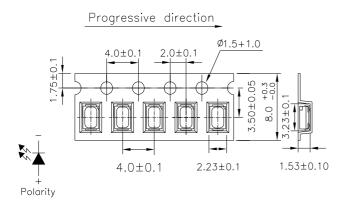


- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- · HUE: Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions

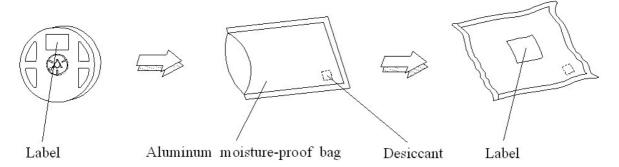


Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Process



Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H:+100°C 15min ∫ 5 min L:-40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions for Use

1. Over-current-proof

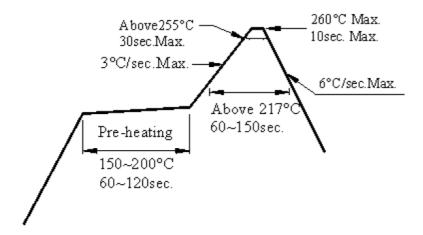
Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change(Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life are 168 hours under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

